

Amendments to the Specification

Please replace paragraph [0003] of the application with the following amended paragraph:

The present document is somewhat related to the co pending and commonly assigned patent application documents “OFF SUBSTRATE FLIP-CHIP APPARATUS AND METHOD”, AFD 00623, serial number 10/690,158 ~~xxx,xxx~~; and “HINGED BONDING OF MICROMECHANICAL DEVICES” AFD 00625, serial number 10/690,159 ~~xxx,xxx~~ that are filed of even date herewith. The contents of these somewhat related applications are hereby incorporated by reference herein.